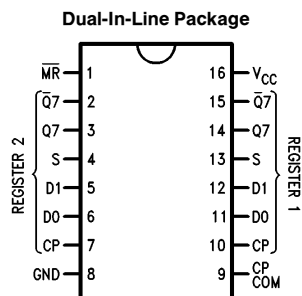


9328/DM9328 Dual 8-Bit Shift Register

General Description

The '9328 is a high speed serial storage element providing 16 bits of storage in the form of two 8-bit registers. The multifunctional capability of this device is provided by several features: 1) additional gating is provided at the input to both shift registers so that the input is easily multiplexed between two sources; 2) the clock of each register may be provided separately or together; 3) both the true and complementary outputs are provided from each 8-bit register, and both registers may be master cleared from a common input.

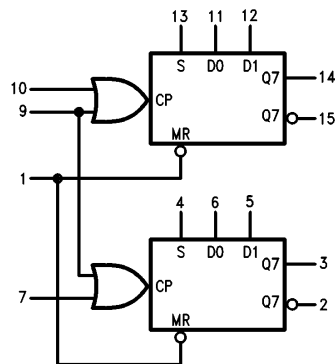
Connection Diagram



TL/F/9793-1

Order Number 9328DMQB, 9328FMQB or DM9328N
See NS Package Number J16A, N16E or W16A

Logic Symbol



TL/F/9793-2

V_{CC} = Pin 16
GND = Pin 8

Pin Names	Description
S	Data Select Input
D0, D1	Data Inputs
CP	Clock Pulse Input (Active HIGH) Common (Pin 9) Separate (Pins 7 and 10)
$\overline{\text{MR}}$	Master Reset Input (Active LOW)
Q7	Last Stage Output
$\overline{\text{Q7}}$	Complementary Output

Absolute Maximum Ratings (Note)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage	7V
Input Voltage	5.5V
Operating Free Air Temperature Range	
Military	−55°C to +125°C
Commercial	0°C to +70°C
Storage Temperature Range	−65°C to +150°C

Note: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the "Electrical Characteristics" table are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Recommended Operating Conditions

Symbol	Parameter	Military			Commercial			Units
		Min	Nom	Max	Min	Nom	Max	
V _{CC}	Supply Voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH}	High Level Input Voltage	2			2			V
V _{IL}	Low Level Input Voltage			0.8			0.8	V
I _{OH}	High Level Output Current			−0.4			−0.4	mA
I _{OL}	Low Level Output Current			16			16	mA
T _A	Free Air Operating Temperature	−55		125	0		70	°C
t _s (H) t _s (L)	Setup Time HIGH or LOW D _n to CP	20 20			20 20			ns
t _h (H) t _h (L)	Hold Time HIGH or LOW D _n to CP	0 0			0 0			ns
t _w (H) t _w (L)	Clock Pulse Width HIGH or LOW	25 25			25 25			ns
t _w (L)	$\overline{MR}$ Pulse Width with CP HIGH	30			30			ns
t _w (L)	$\overline{MR}$ Pulse Width with CP LOW	40			40			ns
t _{rec}	Recovery Time $\overline{MR}$ to CP	33			33			ns

Electrical Characteristics

Over Recommended Operating Free Air Temperature Range (Unless Otherwise Noted)

Symbol	Parameter	Conditions	Min	Typ (Note 1)	Max	Units
V _I	Input Clamp Voltage	V _{CC} = Min, I _I = −12 mA			−1.5	V
V _{OH}	High Level Output Voltage	V _{CC} = Min, I _{OH} = Max V _{IL} = Max	2.4	3.4		V
V _{OL}	Low Level Output Voltage	V _{CC} = Min, I _{OL} = Max V _{IH} = Min		0.2	0.4	V
I _I	Input Current @ Max Input Voltage	V _{CC} = Max, V _I = 5.5V			1	mA
I _{IH}	High Level Input Current	V _{CC} = Max, V _I = 2.4V $\overline{MR}$, D _n Inputs			40	μA
		CP Inputs			60	
		S Inputs			80	
		CP (COM) Inputs			120	
I _{IL}	Low Level Input Current	V _{CC} = Max, V _I = 0.4V $\overline{MR}$, D _n Inputs			−1.6	mA
		CP Inputs			−2.4	
		S Inputs			−3.2	
		CP (COM) Input			−4.8	

Electrical Characteristics

Over Recommended Operating Free Air Temperature Range (Unless Otherwise Noted) (Continued)

Symbol	Parameter	Conditions	Min	Typ (Note 1)	Max	Units
I_{OS}	Short Circuit Output Current	$V_{CC} = \text{Max}$ (Note 2)	MIL	–20	–70	mA
			COMM	–20	–70	
I_{CC}	Supply Current	$V_{CC} = \text{Max}$			77	mA

Note 1: All typicals are at $V_{CC} = 5V$, $T_A = 25^\circ\text{C}$.

Note 2: Not more than one output should be shorted at a time.

Switching Characteristics

$V_{CC} = +5.0V$, $T_A = +25^\circ\text{C}$ (See Section 1 for waveforms and load configurations)

Symbol	Parameter	$C_L = 15\text{ pF}$ $R_L = 400\Omega$		Units
		Min	Max	
f_{max}	Maximum Shift Right Frequency	20		MHz
t_{PLH}	Propagation Delay		20	ns
t_{PHL}	CP to Q7 or $\overline{Q}7$		35	
t_{PHL}	Propagation Delay $\overline{MR}$ to Q7		50	ns

Functional Description

The two 8-bit shift registers have a common clock input (pin 9) and separate clock inputs (pins 10 and 7). The clocking of each register is controlled by the OR function of the separate and the common clock input. Each register is composed of eight clocked RS master/slave flip-flops and a number of gates. The clock OR gate drives the eight clock inputs of the flip-flops in parallel. When the two clock inputs (the separate and the common) to the OR gate are LOW, the slave latches are steady, but data can enter the master latches via the R and S input. During the first LOW-to-HIGH transition of either, or both simultaneously, of the two clock inputs, the data inputs (R and S) are inhibited so that a later change in input data will not affect the master; then the now trapped information in the master is transferred to the slave. When the transfer is complete, both the master and the slave are steady as long as either or both clock inputs remain HIGH. During the HIGH-to-LOW transition of the last remaining HIGH clock input, the transfer path from master to slave is inhibited first, leaving the slave steady in its present state. The data inputs (R and S) are enabled so that new data can enter the master. Either of the clock inputs can be used as clock inhibit inputs by applying a logic HIGH signal.

Each 8-bit shift register has a 2-input multiplexer in front of the serial data input. The two data inputs D0 and D1 are controlled by the data select input (S) following the Boolean expression:

Serial data in: $S_D = SD0 + SD1$

An asynchronous master reset is provided which, when activated by a LOW logic level, will clear all 16 stages independently of any other input signal.

Shift Select Table

INPUTS			OUTPUT
S	D0	D1	Q7 ($t_n + 8$)
L	L	X	L
L	H	X	H
H	X	L	L
H	X	H	H

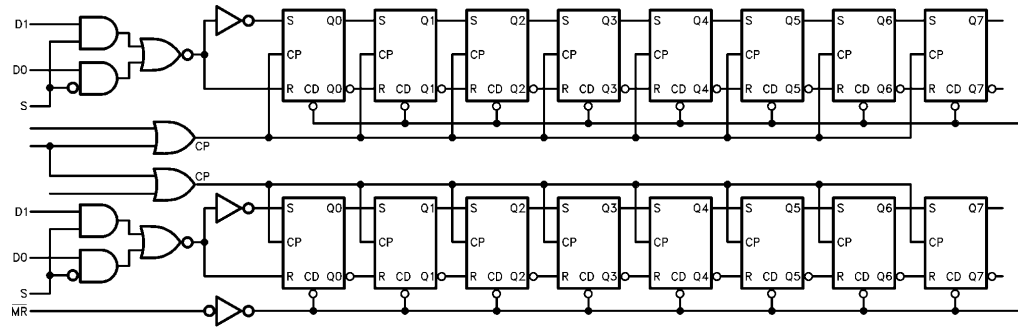
H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial

$n + 8$ = indicates state after eight clock pulse

Logic Diagram



TL/F/9793-3

The drawing illustrates the mechanical specifications for a 16-pin connector assembly. It includes three views: a top view, a side view, and a detail view of the glass sealant.

Top View Dimensions:

- Overall width: 0.785 [19.94] MAX
- Pin pitch (between pins 1 and 8): 0.037 ± 0.005 [0.94 ± 0.13] TYP
- Pin diameter: 0.055 ± 0.005 [1.40 ± 0.13] TYP
- Pin length: 0.020 - 0.060 [0.51 - 1.52] TYP
- Pin angle: 90° ± 4° TYP
- Pin base diameter: 0.018 ± 0.003 [0.46 ± 0.08] TYP
- Pin base length: 0.0100 ± 0.010 [2.54 ± 0.25] TYP
- Pin base width: 0.080 [2.03] MAX BOTH ENDS
- Pin base height: 0.125 - 0.200 [3.18 - 5.08] TYP
- Pin base thickness: 0.005 [0.13] MIN TYP
- Pin base width: 0.200 [5.08] MAX TYP
- Pin base length: 0.150 [3.81] MIN TYP
- Pin base width: 0.025 [0.64] R
- Pin base width: 0.005 - 0.020 [0.13 - 0.51] R

Side View Dimensions:

- Overall height: 0.220 - 0.310 [5.59 - 7.87]
- Pin height: 0.290 - 0.320 [7.37 - 8.13]
- Pin width: 0.180 [4.57] MAX
- Pin angle: 95° ± 5° TYP
- Pin base width: 0.310 - 0.410 [7.87 - 10.41]

Detail View Dimensions:

- Glass sealant thickness: 0.010 ± 0.002 [0.25 ± 0.05]

Other Dimensions:

- Pin 16: 0.005 [0.13] MIN TYP
- Pin 15: 0.005 [0.13] MIN TYP
- Pin 14: 0.005 [0.13] MIN TYP
- Pin 13: 0.005 [0.13] MIN TYP
- Pin 12: 0.005 [0.13] MIN TYP
- Pin 11: 0.005 [0.13] MIN TYP
- Pin 10: 0.005 [0.13] MIN TYP
- Pin 9: 0.005 [0.13] MIN TYP
- Pin 8: 0.005 [0.13] MIN TYP
- Pin 7: 0.005 [0.13] MIN TYP
- Pin 6: 0.005 [0.13] MIN TYP
- Pin 5: 0.005 [0.13] MIN TYP
- Pin 4: 0.005 [0.13] MIN TYP
- Pin 3: 0.005 [0.13] MIN TYP
- Pin 2: 0.005 [0.13] MIN TYP
- Pin 1: 0.005 [0.13] MIN TYP

Notes:

- 0.785 [19.94] MAX
- 0.220 - 0.310 [5.59 - 7.87]
- 0.037 ± 0.005 [0.94 ± 0.13] TYP
- 0.055 ± 0.005 [1.40 ± 0.13] TYP
- 0.020 - 0.060 [0.51 - 1.52] TYP
- 90° ± 4° TYP
- 0.018 ± 0.003 [0.46 ± 0.08] TYP
- 0.0100 ± 0.010 [2.54 ± 0.25] TYP
- 0.080 [2.03] MAX BOTH ENDS
- 0.125 - 0.200 [3.18 - 5.08] TYP
- 0.005 [0.13] MIN TYP
- 0.200 [5.08] MAX TYP
- 0.150 [3.81] MIN TYP
- 0.025 [0.64] R
- 0.005 - 0.020 [0.13 - 0.51] R
- 0.290 - 0.320 [7.37 - 8.13]
- 0.180 [4.57] MAX
- 95° ± 5° TYP
- 0.310 - 0.410 [7.87 - 10.41]
- 0.010 ± 0.002 [0.25 ± 0.05]

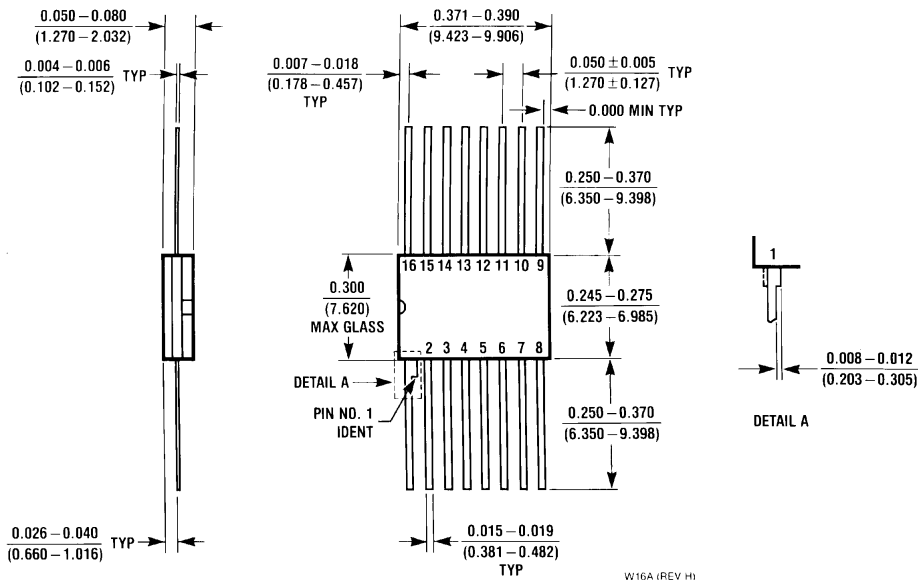
Material: GLASS SEALANT

Part Number: J16A (REV L)

The mechanical drawings of the N16E connector are as follows:

- Top View:** Shows the connector's footprint. Dimensions include a total width of $0.740 - 0.780$ (18.80 - 19.81), a pin pitch of 0.090 (2.286), and a pin diameter of 0.250 ± 0.010 (6.350 ± 0.254). Pin numbers 1 through 16 are indicated.
- Side View:** Shows the connector's profile. Dimensions include a total height of 0.130 ± 0.005 (3.302 ± 0.127), a pin height of $0.145 - 0.200$ (3.683 - 5.080), and a pin thickness of 0.020 (0.508). The pin angle is specified as 4° TYP.
- End View:** Shows the connector's end profile. Dimensions include a total width of $0.300 - 0.320$ (7.620 - 8.128), a pin width of 0.065 (1.651), and a pin thickness of $0.008 - 0.016$ (0.203 - 0.406). The pin angle is specified as $95^\circ \pm 5^\circ$.

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Physical Dimensions inches (millimeters) (Continued)

16-Lead Ceramic Flat Package (W)
Order Number 9328FMQB
NS Package Number W16A

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